

# HSP

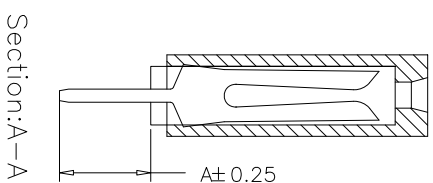
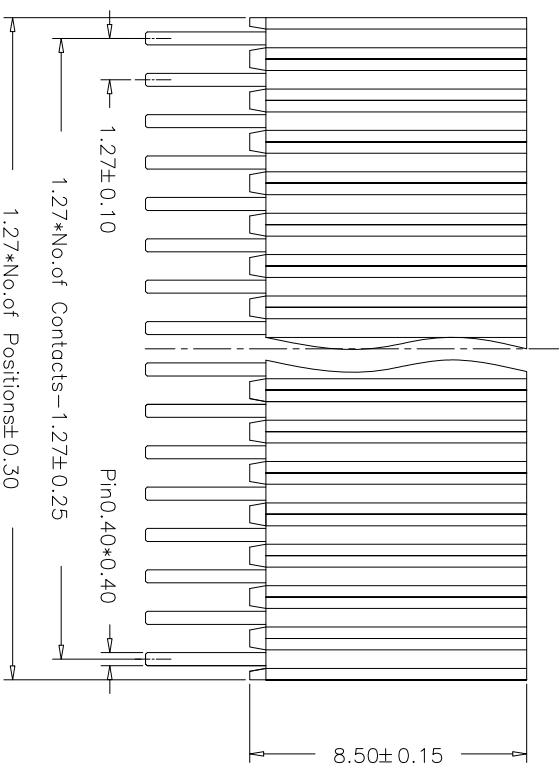
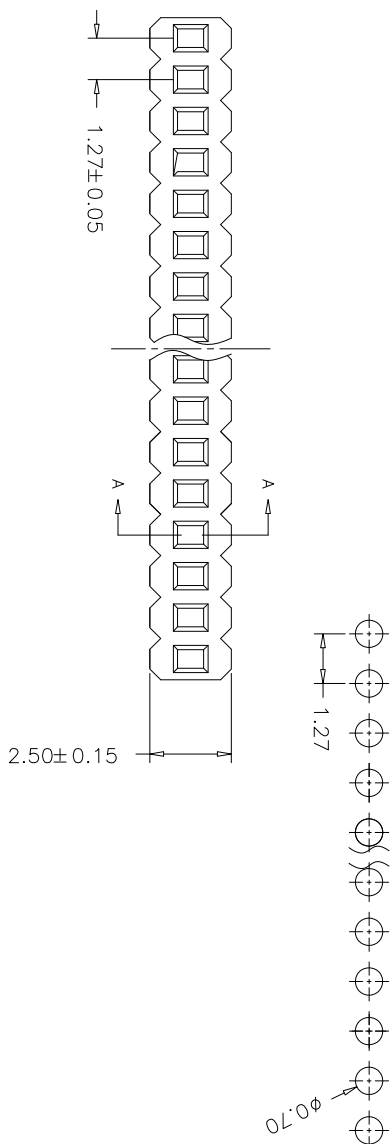
Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

NOTES:  
 Current Rating: 1.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ min  
 Operation Temperature: -40℃ to +105℃  
 Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn Over Nickel  
 Insulator Material: PA6T+30%G.F (UL94V-0)

## Ordering Information

BT2385 1 \* \* \* 01 J 1 A01

I=Single Row No.of Pins Contact Plating Dip Length Packing Contact Shape&Plastic High  
 02-50 U=Gold Flash See Table J:PA6T+Tube I: Straight, H=8.5mm  
 X=1.0u"Gold K:PA6T+Tape&Reel  
 W=1.5u"Gold  
 Y=2.0u"Gold  
 Z=3.0u"Gold  
 F=Gold Flash/Tin  
 A=10u"Gold/Tin  
 J=1.5u"Gold/Tin  
 K=3.0u"Gold/Tin  
 S=Tin Plated  
 N=Nickel Plated



ITEM	A
01	2.80
02	

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	Zhongyulin	09/01/11	SCALE	UNIT	SIZE	SHEET	PART NO.	TITLE:
A0	09/01/11	NEW			XX ±0.45	DESIGN			mm	A4	1/1	BT23851***01J1A01	FH1.27mm Single Row 180° H=8.50mm	
					X XX ±0.30	CHECK								
					X XXX ±0.20									
					Angle ± 3'	APPROVE								
					DIM TOL									

